Electronic Patent Application Fee Transmittal								
Application Number:	10581430							
Filing Date:	02-Jun-2006							
Title of Invention:	Bonding method, device produced by this method, and bonding device							
First Named Inventor/Applicant Name:	Masuaki Okada							
Filer:	Ajay A. Jagtiani/g mills							
Attorney Docket Number:	YANE-0002-US1							
Filed as Large Entity								
U.S. National Stage under 35 USC 371 Filing Fees								
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:								
Pages:								
Claims:								
Claims in excess of 20		1615	14	50	700			
Independent claims in excess of 3		1614	6	210	1260			
Miscellaneous-Filing:								
Petition:								
Patent-Appeals-and-Interference:								
Post-Allowance-and-Post-Issuance:								

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
	Total in USD (\$)			1960